

04-12-2004



Form PTO-1595
(Rev. 10/02)
OMB No. 0651-0027 (exp. 6/30/2005)

U.S. DEPARTMENT OF COMMERCE
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102719067
PATENTS ONLY

Tab settings ⇌ ⇌ ⇌

To the honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

CMC Wireless Components, Inc.
10409 S. 50th Place
Phoenix, Arizona 85044

4-804

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: 4-1-04

2. Name and address of receiving party(ies)

Name: CMC Interconnect Technologies, Inc.

Internal Address: _____

Street Address: 7755 South Research Drive

City: Tempe State: Arizona Zip: 85284

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

B. Patent No.(s)

5,311,399

Additional numbers attached? ☒ Yes ☐ No

OPR/FINANCE
10-5 AM 7-01

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Joseph G. Curatolo

Renner, Kenner, Greive, Bobak, Taylor & Weber

Internal Address: _____

Street Address: 24500 Center Ridge Road

Suite 280

City: Westlake State: OH Zip: 44145

6. Total number of applications and patents involved:

11

7. Total fee (37 CFR 3.41). \$440.00

☒ Enclosed

☐ Authorized to be charged to deposit account

8. Deposit account number:

18-0987

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Joseph G. Curatolo

Name of Person Signing

Joseph G. Curatolo

Signature

4-6-2004

Date

Total number of pages including cover sheet, attachments, and documents: 4

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

04/09/2004 MGETACHE 00000067 5311399

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PATENT
REEL: 015177 FRAME: 0587

Attachment to PTO-1595
Additional United States Issued Patents

U.S Patent Number
5,324,570
5,424,261
5,541,145
5,552,107
5,552,232
5,682,589
5,763,093
5,773,377
5,888,446
6,399,182

ASSIGNMENT

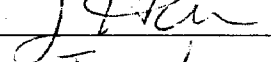
THIS ASSIGNMENT, effective as of the 1st day of January, 2004, from Assignor, CMC Wireless Components, Inc., a California corporation, of 10409 S. 50th Place, Phoenix, Arizona 85044, to Assignee, CMC Interconnect Technologies, Inc., an Arizona corporation, with its principal place of business at 7755 South Research Drive, Tempe, Arizona 85284;

WHEREAS, as of the effective date, Assignor sold, transferred and assigned to Assignee for its free and unrestricted use, Assignor's entire right, title and interest in and to the United States Letters Patent listed in Annex A ("the Patents") to the full end of the respective terms for which the Patents are granted;

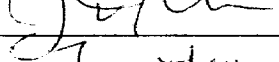
WHEREAS, Assignor has agreed to execute all documents and assignments to the extent necessary to record the transfer of Assignor's entire right, title and interest in and to the Patents to Assignee;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Assignor, CMC Wireless Components, Inc., hereby perfects the sale, transfer and assignment, *nunc pro tunc*, to Assignee, CMC Interconnect Technologies, Inc., of its entire right, title and interest in and to the Patents, and any other Letters Patent which may be granted thereon in the United States and in all foreign countries, including all continuations, continuations-in-part, divisions, and renewals or extensions thereof, or any reissue or reexamination resulting therefrom, including the right to claim priority therefrom, for Assignee's use and enjoyment and that of Assignee's successors, assigns or other legal representatives, along with all causes of action, rights and remedies under the Patents or such other Letters Patent, prior to or after the effective date hereof.

Assignor:
CMC Wireless Components, Inc.

By 
Name Jonathan Harris
Title President
Date 4-1-04

Assignee:
CMC Interconnect Technologies, Inc.

By 
Name Jonathan Harris
Title President
Date 4-1-04

CMC Patent Portfolio

U.S Patent Number	Title
5,311,399	High Power Ceramic Microelectronic Package
5,324,570	Microelectronics Package
5,424,261	Low Temperature Sintering Route For Aluminum Nitride Ceramics
5,541,145	Low Temperature Sintering Route For Aluminum Nitride Ceramics
5,552,107	Aluminum Nitride Body Having Graded Metallurgy
5,552,232	Aluminum Nitride Body Having Graded Metallurgy
5,682,589	Aluminum Nitride Body Having Graded Metallurgy
5,763,093	Aluminum Nitride Body Having Graded Metallurgy
5,773,377	Low Temperature Sintered, Resistive Aluminum Nitride Ceramics
5,888,446	Method Of Forming An Aluminum Nitride Article Utilizing A Platinum Catalyst
6,399,182	Die Attachment Utilizing Grooved Surfaces